

DRV10963 5V、三相无传感器 BLDC 电机驱动器

1 特性

- 专有无传感器无窗口 180°正弦控制机制
- 输入电压范围：2.1V 至 5.5V
- 500mA 输出电流
- 休眠模式下的静态电流低至 15 μ A（典型值）
- 驱动器高侧和低侧 (H+L) 总导通电阻 (Rdson) 少于 1.5 Ω
- 电流限制和短路电流保护
- 锁定检测
- 电压浪涌保护 (AVS)
- 欠压闭锁 (UVLO)
- 热关断

2 应用范围

- 笔记本 CPU 风扇
- 游戏站 CPU 风扇
- ASIC 冷却风扇

3 说明

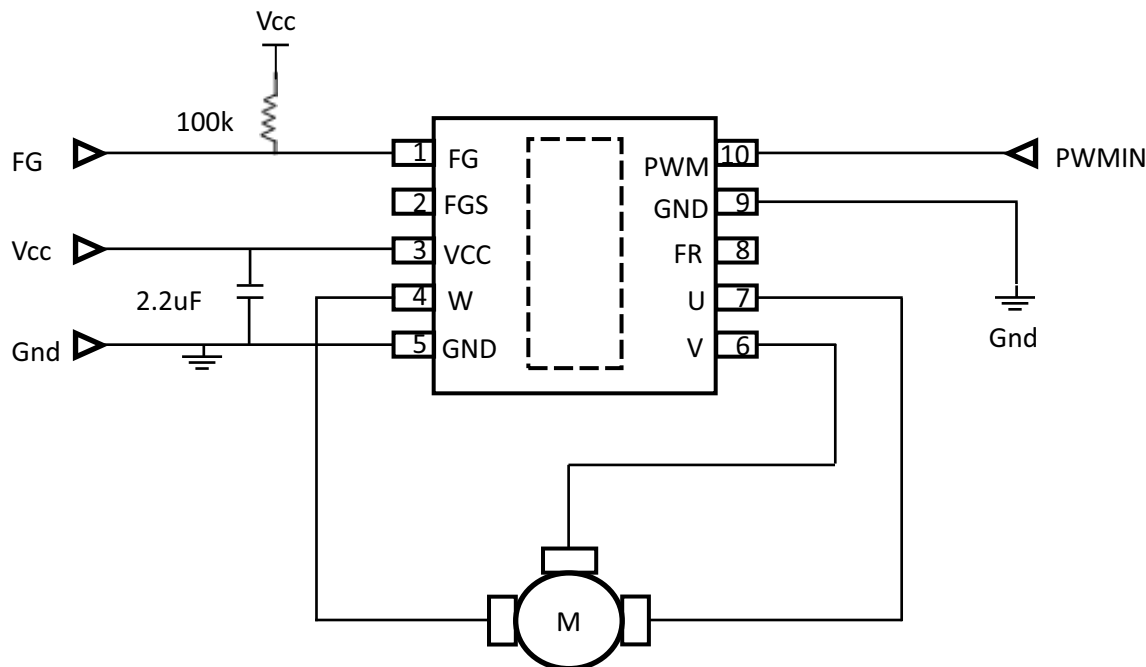
DRV10963 是一款带有集成功率金属氧化物半导体场效应管 (MOSFET) 的三相无传感器电机驱动器。该器件专门针对高效、低噪声和低外部组件数的电机驱动应用而设计。专有的无传感器无窗口 180° 正弦控制机制可提供极度安静的电机驱动性能。DRV10963 具备智能锁定检测功能，与其他内部保护电路搭配使用以确保器件安全运行。DRV10963 采用带有外露散热焊盘的高效散热型 10 引脚超小外形尺寸无引线 (USON) 封装。

器件信息

器件型号	封装	封装尺寸 (标称值)
DRV10963	USON (10)	3.00mm x 3.00mm

(1) 要了解所有可用封装，请见数据表末尾的可订购产品附录。

简化电路原理图



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4 修订历史记录

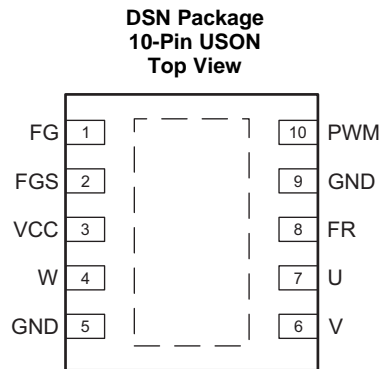
注：之前版本的页码可能与当前版本有所不同。

Changes from Original (March 2013) to Revision A

Page

• 已添加 ESD 额定值表，特性描述部分，器件功能模式，应用和实施部分，电源相关建议部分，布局部分，器件和文档支持部分以及机械、封装和可订购信息部分	1
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5 Pin Configuration and Functions



Pin Functions

PIN		I/O	DESCRIPTION
NUMBER	NAME		
1	FG	Output	Motor speed indicator output (open drain)
2	FGS	Input	Motor speed indicator selector. The state of this pin is latched on power up and can not be changed dynamically.
3	VCC	Power	Input voltage for motor and chip supply
4	W	IO	Motor Phase W
5	GND	Ground	Ground
6	V	IO	Motor Phase V
7	U	IO	Motor Phase U
8	FR	Input	Motor direction selector. This pin can be dynamically changed after power up.
9	GND	Ground	Ground
10	PWM	Input	Motor speed control input.
—	Thermal Pad	—	Connect to Ground for maximum thermal efficiency. Thermal pad is on the bottom of the package

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)^{(1) (2)}

		MIN	MAX	UNIT
	VCC Pin supply voltage	-0.3	6	V
	Motor phase pins (U, V, W)	-1	7.7	V
	Direction, speed indicator input, and speed input (FR, FGS, PWM)	-0.3	6	V
	Speed output (FG)	-0.3	7.7	V
T _J	Junction temperature	-40	150	°C
T _{SDR}	Maximum lead soldering temperature, 10 seconds		260	°C
T _{stg}	Storage temperature	-55	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to ground.

6.2 ESD Ratings

		VALUE	UNIT
V _(ESD)	Electrostatic discharge		V
	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±3000	
	Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±1500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
VCC	VCC Pin supply voltage	2.1	5.5	V
U, V, W	Motor phase pins	-0.1	7	V
FR, FGS, PWM	Direction, speed indicator input, and speed input	-0.1	5.5	V
FG	Speed output	-0.1	7.5	V
T _J	Junction temperature	-40	125	°C

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		DRV10963	UNIT
		DSN (USON)	
		10 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	40.9	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	46.6	°C/W
R _{θJB}	Junction-to-board thermal resistance	15.8	°C/W
ψ _{JT}	Junction-to-top characterization parameter	0.5	°C/W
ψ _{JB}	Junction-to-board characterization parameter	16	°C/W
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	2.9	°C/W

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

6.5 Electrical Characteristics

(V_{CC} = 5 V, T_A = 25°C unless otherwise noted)

PARAMETER		TEST CONDITION	MIN	TYP	MAX	UNIT
SUPPLY CURRENT						
I _{VCC}	Operating current	PWM = V _{CC} , no motor connected		5.5		mA
I _{VCC_SLEEP}	Sleep current	PWM = 0 V		15	20	μA
UVLO						
V _{UVLO_H}	Undervoltage threshold high			2	2.1	V
V _{UVLO_L}	Undervoltage threshold low		1.7	1.8		V
V _{UVLO_HYS}	Undervoltage threshold hysteresis		100	200	300	mV
INTEGRATED MOSFET						
R _{DS(on)}	Series resistance (H+L)	V _{CC} = 5 V; I _{OUT} = 0.5 A		1	1.5	Ω
PWM						
V _{IH_PWM}	Input high threshold		2.3			V
V _{IL_PWM}	Input low threshold				0.8	V
F _{PWM}	PWM input frequency	Duty cycle >0% and <100%	15		100	kHz
R _{PU_PWM_VCC}	PWM pin pullup resistor	Active Mode		50		kΩ
		Standby Mode		2		MΩ
T _{SLEEP}	Sleep entry time	PWM = 0 V		500		μs
FG						
I _{OL_FG}	FG sink current	V _{FG} = 0.3 V	5			mA
I _{SC_FG}	FG short circuit current	V _{FG} = 5 V		13	25	mA
FGS and FR						
V _{IH_FGS}	Input high threshold		2.3			V
V _{IL_FGS}	Input low threshold				0.8	V
V _{IH_FR}	Input high threshold		2.3			V
V _{IL_FR}	Input low threshold				0.8	V
R _{PU_FGS_VCC}	FGS pin pullup resistor	Active Mode		50		kΩ
		Standby Mode		2		MΩ
R _{PU_FR_VCC}	FR pin pullup resistor			500		kΩ
LOCK PROTECTION						
T _{ON_LOCK}	Lock detect time			0.3		s
T _{OFF_LOCK}	Lock release time			5		s
CURRENT LIMIT						
I _{LIMIT}	Soft current limit value			500		mA
SHORT CIRCUIT CURRENT PROTECTION [I_{LIMIT} [2:0] = 4]						
I _{SHT}	Short circuit current protection			1.8		A
THERMAL SHUTDOWN						
T _{SD}	Thermal shutdown temperature			160		°C
T _{SD_HYS}	Thermal shutdown hysteresis			10		°C

6.6 Typical Characteristics

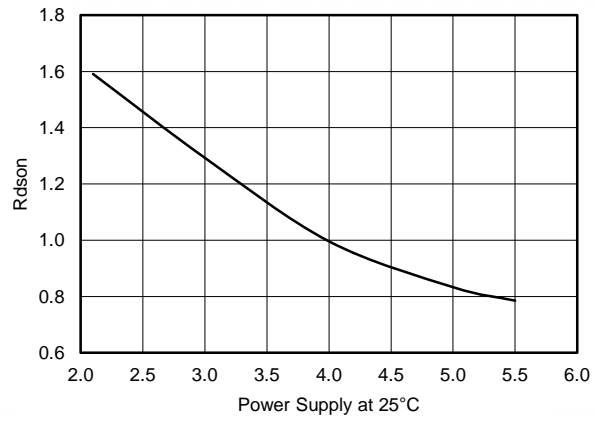


Figure 1. $R_{DS(on)}$ vs Power Supply at 25°C

7 Detailed Description

7.1 Overview

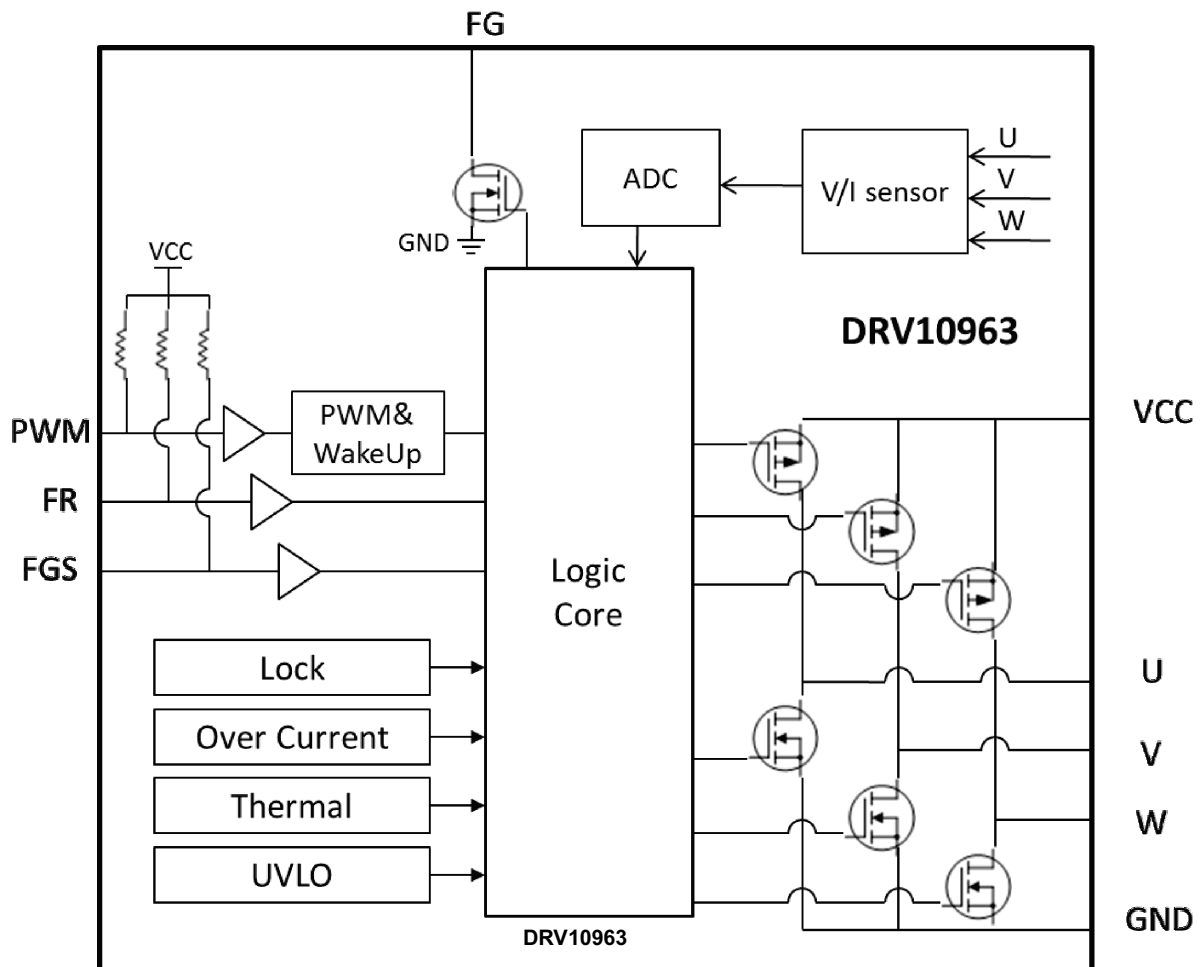
The DRV10963 device is a three phase sensor-less motor driver with integrated power MOSFETs. It is specifically designed for high efficiency, low noise and low external component count motor drive applications. The proprietary sensor-less window-less 180° sinusoidal control scheme provides ultra-quiet motor operation by keeping electrically induced torque ripple small.

Upon start-up, the DRV10963 device will spin the motor in the direction indicated by the FR input pin. The DRV10963 device will operate a three phase BLDC motor using a sinusoidal control scheme. The magnitude of the applied sinusoidal phase voltages is determined by the duty cycle of the PWM pin. As the motor spins, the DRV10963 device provides the speed information at the FG pin.

The DRV10963 device contains an intelligent lock detect function. In the case where the motor is stalled by an external force, the system will detect the lock condition and will take steps to protect itself as well as the motor. The operation of the lock detect circuit is described in detail in [Lock Detection](#).

The DRV10963 device also contains several internal protection circuits such as overcurrent protection, overvoltage protection, undervoltage protection, and overtemperature protection.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Speed Input and Control

The DRV10963 provides 3-phase 25-kHz PWM outputs which have an average value of sinusoidal waveforms from phase to phase. When any phase is measured with reference to ground, the waveform observed will be a PWM encoded sinusoid coupled with 3rd order harmonics as shown in Figure 2. This encoding scheme simplifies the driver requirements because there will always be one phase output that is equal to zero.

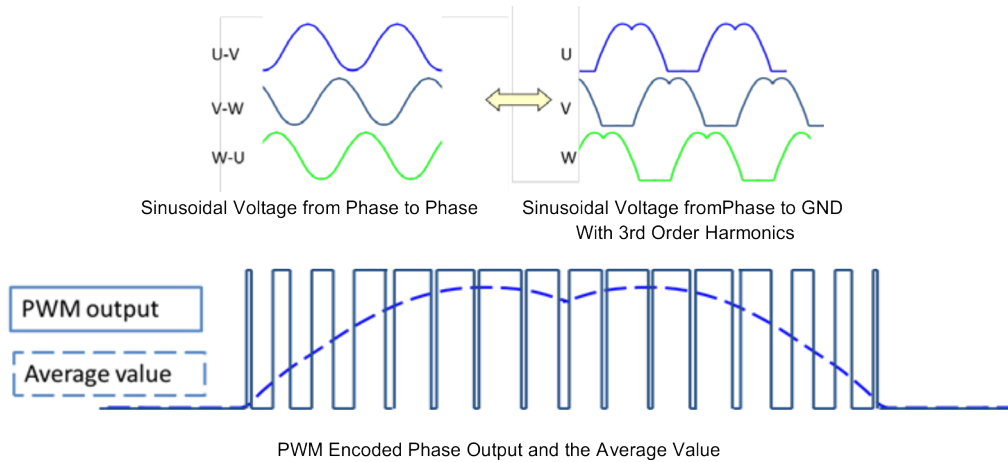


Figure 2. Sinusoidal Phase Encoding Used in DRV10963

The output amplitude is determined by the supply voltage (VCC) and the commanded PWM duty cycle (PWM) as described in Equation 1 and illustrated in Figure 3. The maximum amplitude is applied when the commanded PWM duty cycle is 100%.

$$V_{ph_{pk}} = PWMdc \times VCC \tag{1}$$

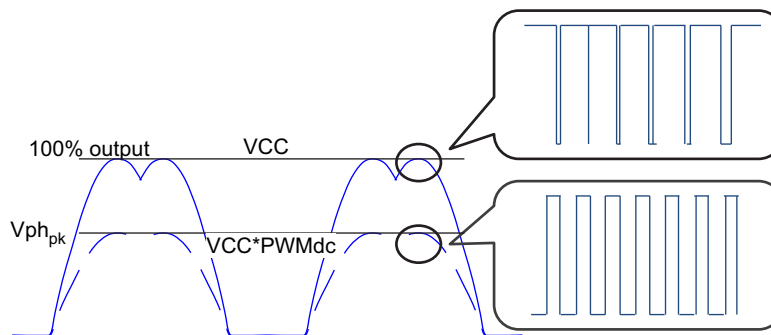


Figure 3. Output Voltage Amplitude Adjustment

The motor speed is controlled indirectly by using the PWM command to control the amplitude of the phase voltages which are applied to the motor.

The duty cycle of PWM input is converted into a 9 bit digital number (from 0 to 511). The control resolution is $1/512 \approx 0.2\%$. The duty cycle analyzer implements a first order transfer function between the input duty cycle and the 9 bits digital number. This is illustrated in Figure 4, where $\tau=80$ ms.

Feature Description (continued)

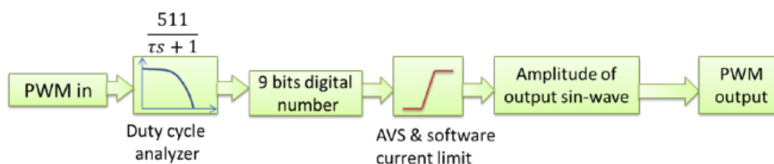


Figure 4. PWM Command Input Controls the Output Peak Amplitude

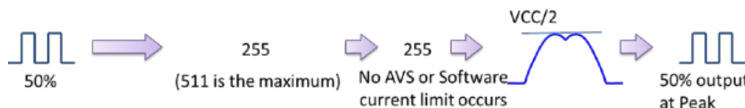


Figure 5. Example of PWM Command Input Controlling the Output

The transfer function between the PWM commanded duty cycle and the output peak amplitude is adjustable in the DRV10963 device. The output peak amplitude is described by Equation 1 when PWMcommand > minimum operation duty cycle. The minimum operation duty cycle can be set to either 13%, 10%, 5% or no limit by OTP setting (MINOP_DC[1:0]). Table 1 shows the optional settings for the minimum operation duty cycle. When the PWM commanded duty cycle is lower than minimum operation duty cycle and higher than 1.5%, the output will be controlled at the minimum operation duty cycle. When the input duty cycle is lower than 1.5%, the DRV10963 device will not drive the output, and enters the standby mode. This is illustrated in Figure 6.

Table 1. Minimum Operation Duty Cycle

MINOP_DC[1:0]	MINIMUM OPERATION DUTY CYCLE
0	0 (no limit)
1	5%
2	10%
3	13%

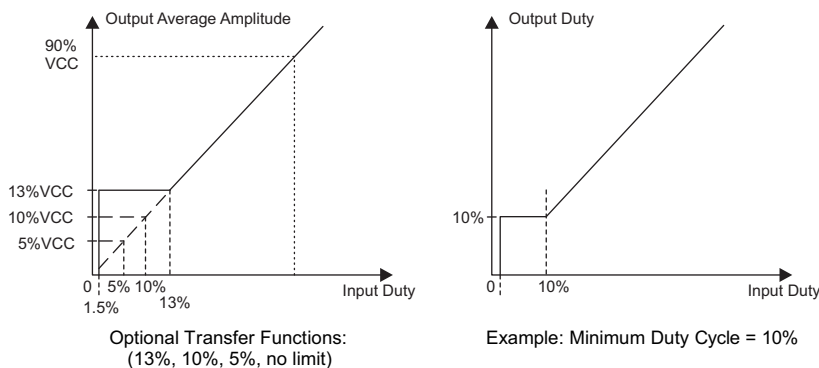


Figure 6. Speed Control Transfer Function

7.3.2 Spin up Settings

DRV10963 starts the motor using a procedure which is illustrated in Figure 7.

The motor start profile includes device configurable options for open loop to close loop transition threshold (H_{Offth}), align time (T_{Align}), and accelerate rate (R_{Acc}).

To align the rotor to the commutation logic the DRV10963 applies an x% duty cycle on phases V and W while holding phase U at GND. This condition is maintained for T_{Align} seconds. The x% value is determined by the VCC voltage (as shown in Table 2) to maintain sufficient driving torque over a wide range of supply voltages.

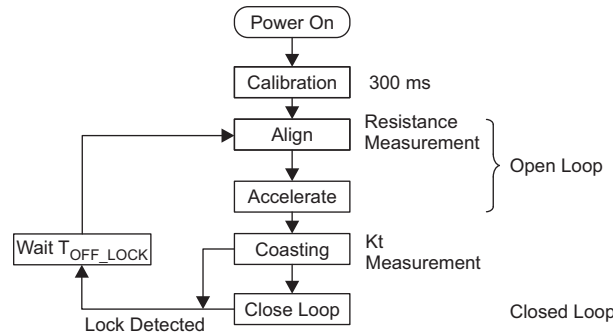


Figure 7. DRV10963 Initialization and Motor Start-up Sequence

Table 2. Align and Open Loop Duty Cycle

VCC VOLTAGE	DUTY CYCLE DURING ALIGN AND OPEN LOOP (X)%
5.25 to approximately 6 V	43%
4.5 to approximately 5.25 V	50%
3.75 to approximately 4.5 V	60%
3 to approximately 3.75 V	75%
<3	100%

When the align phase completes, the motor is accelerated by applying sinusoidal phase voltages with peak magnitudes as illustrated in Table 2 and stepping through the commutation sequence at an increasing rate described by R_{Acc} until the rate of commutation reaches H_{Offth} Hz. When this threshold is reached, the DRV10963 switches to closed loop mode where the commutation drive sequence is determined by the internal control algorithm and the applied voltage is determined by the PWM commanded duty cycle input. The open loop to close loop transition threshold (H_{Offth}), align time (T_{Align}), and the accelerate rate (R_{Acc}) are device configurable through OTP settings (HO_TH[3:0], TARA_TH[3:0]).

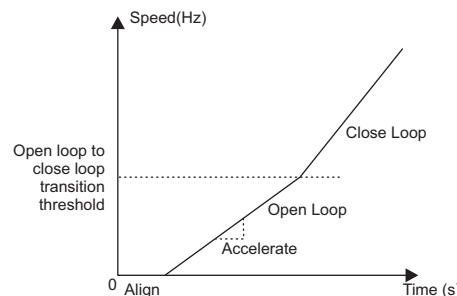


Figure 8. DRV10963 Start-up Profile

The selection of handoff threshold (H_{Offth}) can be determined by experimental testing. The goal is to choose a handoff threshold that is as low as possible and allows the motor to smoothly and reliably transition between the open loop acceleration and the closed loop acceleration. Normally higher speed motors (maximum speed) require a higher handoff threshold because higher speed motors have lower K_t and as a result lower BEMF. Table 3 shows the configurable settings for the handoff threshold. Maximum speed in electrical Hz are shown as a guide to assist in identifying the appropriate handoff speed for a particular application.

Table 3. Motor Handoff Speed Threshold Options

MAXIMUM SPEED (Hz)	H _{Offth} (Hz)	HO_TH [3:0]
<100	12.5	1
100 to approximately 150	25	2
150 to approximately 200	37.5	3
200 to approximately 250	50	4
250 to approximately 300	62.5	5
300 to approximately 350	75	6
350 to approximately 400	87.5	7
400 to approximately 450	100	8
450 to approximately 500	112.5	9
500 to approximately 560	125	A
560 to approximately 620	137.5	B
620 to approximately 700	150	C
700 to approximately 800	162.5	D
800 to approximately 900	175	E
>900	187.5	F

The selection of align time (T_{Align}) and accelerate rate (R_{Acc}) can also be determined by experimental testing. Motors with higher inertia typically require a longer align time and slower accelerate rate while motors with low inertia typically require a shorter align time and a faster accelerate rate. System tradeoffs should be done to optimize start up reliability versus spin up time. TI recommends starting with choosing the less aggressive settings (slow R_{Acc} and large T_{Align}) to sacrifice the spin up time in favor of highest success rate. Once the system is verified to work reliably the more aggressive settings (higher R_{Acc} and smaller T_{Align}) can be used to decrease the spin up time while carefully monitoring the success rate.

Table 4 shows the configurable settings for T_{Align} and R_{Acc} .

Table 4. Motor Alignment and Accelerate Options

T _{Align} (ms)	R _{Acc} (Hz/s)	TARA_TH[3:0]
40	150	1
80	140	2
120	130	3
160	120	4
200	110	5
240	100	6
280	90	7
320	80	8
360	70	9
400	60	A
440	50	B
480	40	C
520	30	D
560	20	E
600	10	F

7.3.3 Motor Direction Change

The DRV10963 can be easily configured to drive the motor in either direction by setting the input on the FR (Forward Reverse) pin to a logic 1 or logic 0 state. The direction of commutation as described by the commutation sequence is illustrated in Table 5.

Table 5. Motor Direction Phase Sequencing

	FR = 10	FR = 01
Motor direction	U->V->W	U->W->V

7.3.4 Motor Frequency Feedback (FG)

During operation of the DRV10963 device, the FG pin provides an indication of the speed of the motor. The output provided on this pin can be configured by use of an OTP setting (FGOPT) and by applying a logic signal to the FGS pin. The configuration of this output is defined in [Table 6](#).

Table 6. FG Motor Status Speed Indicator Configuration

MOTOR CONDITION	(FGS = 1)	FGOPT=1,(FGS = 0)	FGOPT=0,(FGS = 0)
DRV10963xxDSNR Normal Operation	Toggles once per electrical cycle	Toggles once every 2 electrical cycles	Toggles once every 3 electrical cycles

As seen in [Table 6](#), the FG pin can be configured to toggle either once per electrical cycle, once per 2 electrical cycles or once per every 3 electrical cycles. Using this information and the number of pole pairs in the motor, the mechanical speed of the motor can be determined.

The formula to determine the speed of the motor is:

$$\text{If FGS} = 1, \text{RPM} = (\text{FREQFG} \times 60) / \text{number of pole pairs} \quad (2)$$

$$\text{If FGS} = 0, \text{FGOPT} = 1, \text{RPM} = (\text{FREQFG} \times 120) / \text{number of pole pairs} \quad (3)$$

or

$$\text{If FGS} = 0, \text{FGOPT} = 0, \text{RPM} = (\text{FREQFG} \times 180) / \text{number of pole pairs} \quad (4)$$

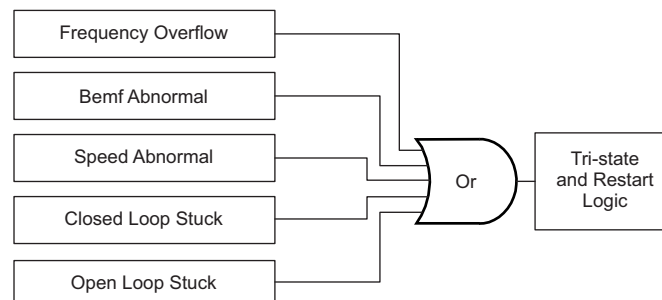
The FG pin has built in short circuit protection, which limits the current in the event that the pin is shorted to VCC. The current will be limited to I_{SC_FG} .

7.3.5 Lock Detection

When the motor is locked by some external condition the DRV10963 will detect the lock condition and will take action to protect the motor and the device. The lock condition must be properly detected whether it occurs as a result of a slowly increasing load or a sudden shock.

The DRV10963 reacts to lock conditions by stopping the motor drive. To stop driving the motor the phase outputs are placed into a high impedance state. To prevent the current which is flowing in the motor from being returned to the power supply (VCC) the DRV10963 uses an **ANTI VOLTAGE SURGE** feature. This feature is described in a following section. After successfully transitioning into a high impedance state as the result of a lock condition the DRV10963 will attempt to restart the motor after T_{OFF_LOCK} seconds.

The DRV10963 has a comprehensive lock detect function which includes 5 different lock detect schemes. Each of these schemes detects a particular condition of lock as illustrated in [Figure 9](#).


Figure 9. Lock Detect

The behavior of each lock detect scheme is described in the following sections.

7.3.5.1 Lock1: Frequency Overflow

For most applications the maximum electrical frequency of the motor will be less than 3 kHz. If the motor is stopped then the BEMF voltage will be zero. Under this condition, when the DRV10963 device is in the closed loop mode, the sensor less control algorithm will continue to accelerate the electrical commutation rate even though the motor is not spinning. A lock condition is triggered if the electrical frequency exceeds 3 kHz.

7.3.5.2 Lock2: BEMF Abnormal

For any specific motor, the integrated value of BEMF during half of an electronic cycle will be a constant as illustrated by the shaded green area in Figure 10. This is true regardless of whether the motor runs fast or slow. The DRV10963 monitors this value and uses it as a criterion to determine if the motor is in a lock condition.

The DRV10963 uses the integrated BEMF to determine the K_t value of the motor during the initial motor start. Based on this measurement a range of acceptable K_t values is established. This range is referred to as K_{t_low} and K_{t_high} . During closed loop motor operation the K_{tc} value is continuously updated. If the calculated K_{tc} goes beyond the acceptable range a lock condition is triggered. This is illustrated in Figure 11.

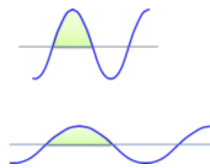


Figure 10. BEMF Integration

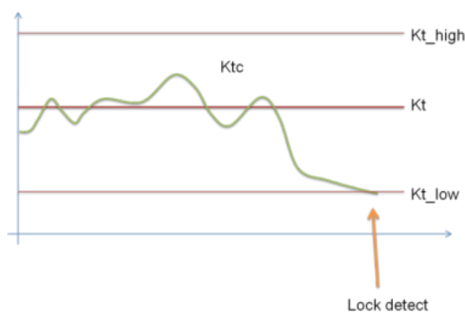


Figure 11. Abnormal K_t Lock Detect

7.3.5.3 Lock3: Speed Abnormal

If the motor is in normal operation the motor BEMF will always be less than the voltage applied to the phase. The DRV10963 sensorless control algorithm is continuously updating the value of the motor BEMF based on the speed of the motor and the motor K_t as shown in Figure 12. If the calculated value for motor BEMF is higher than the applied voltage (U) for a certain period of time (TON_LOCK) then there is an error in the system. The calculated value for motor BEMF is wrong or the motor is out of phase with the commutation logic. When this condition is detected a lock detect is triggered.

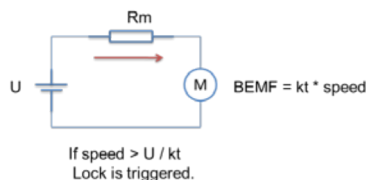


Figure 12. BEMF Monitoring

7.3.5.4 Open Loop Stuck

This lock condition is active when the DRV10963 device is operating in the open loop mode. When the open loop commutation rate becomes higher than the open to closed loop threshold (H_{Offth} - see [Figure 8](#)) and the zero cross is not detected for the time corresponding to 2 electrical cycles then this is an indication that the motor is not moving. Under this condition the open loop stuck lock condition will be triggered.

7.3.6 Soft Current Limit

The current limit function provides active protection for preventing damage as a result of high current. The soft current limit does not use direct current measurement for protection, but rather, uses the measured motor resistance (R_m) and motor velocity constant (K_t) to limit the voltage applied to the phase (U) such that the current does not exceed the limit value (I_{LIMIT}). This is illustrated in [Figure 13](#) based on the calculation shown in [Equation 5](#).

The soft limit is only active when in normal closed loop mode and does not result in a fault condition nor does it result in the motor being stopped. The soft current limit is typically useful for limiting the current that results from heavy loading during motor acceleration.

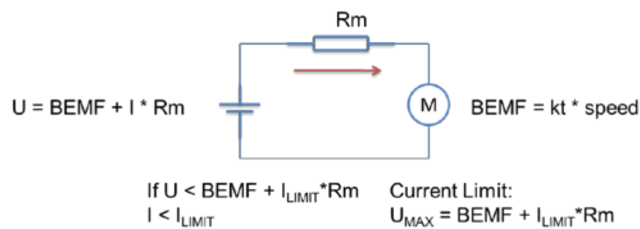


Figure 13. Current Limit

$$U_{LIMIT} = I_{LIMIT} \times R_m + \text{Speed} \times K_t \quad (5)$$

I_{LIMIT} is configured by OTP setting ($I_{LIMIT} [2:0]$) according to [Table 7](#).

NOTE

The soft current limit calculation is not correct if the motor is out of phase with the commutation control logic (locked rotor). The soft current limit will not be effective under this condition.

Table 7. I_{LIMIT} Settings

$I_{LIMIT} [2:0]$	I_{LIMIT}
0	No current limit
1	125 mA
2	250 mA
3	375 mA
4	500 mA
5	625 mA
6	750 mA
7	875 mA

7.3.7 Short Circuit Current Protection

The short circuit current protection function shuts off drive to the motor by placing the motor phases into a high impedance state if the current in any motor phase exceeds the short circuit protection limit I_{SHT} . The DRV10963 device will go through the initialization sequence and will attempt to restart the motor after the short circuit condition is removed. This function is intended to protect the device and the motor from catastrophic failure when subjected to a short circuit condition.

7.3.8 Anti-Voltage Surge (AVS)

Under normal operation the DRV10963 acts to transfer energy from the power supply to the motor to generate torque, which results in angular rotation of the motor. Under certain conditions, however, energy which is stored in the motor in the form of inductive energy or angular momentum (mechanical energy) can be returned to the power supply. This can happen whenever the output voltage is quickly interrupted or whenever the voltage applied to the motor becomes less than the BEMF voltage generated by the motor. The energy which is returned to the supply can cause the supply voltage to increase. This condition is referred to as voltage surge.

The DRV10963 includes an anti-voltage-surge (AVS) feature which prevents energy from being transferred from the motor to the power supply. This feature helps to protect the DRV10963 as well as any other components that are connected to the power supply (VCC).

7.3.8.1 Protecting Against the Return of Mechanical Energy

Mechanical energy is typically returned to the power supply when the speed command is abruptly decreased. If the voltage applied to the phase becomes less than the BEMF voltage then the motor will work as a generator and current will flow from the motor back to VCC. This is illustrated in Figure 14. To prevent this from happening, the DRV10963 buffers the speed command value and limits the rate at which it is able to change. The AVS function acts to ensure that the effective output amplitude (U) is maintained to be larger than the BEMF voltage. This prevents current from becoming less than zero. The value of BEMF used to perform this function is calculated by the motor Kt and the motor speed.

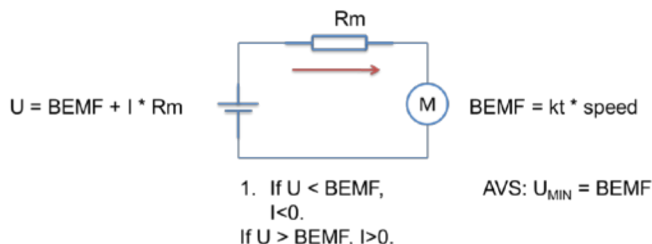


Figure 14. Mechanical AVS

7.3.8.2 Protecting Against the Return of Inductive Energy

When the DRV10963 suddenly stops driving the motor, the current which is flowing in the motor's inductance will continue to flow. It flows through the intrinsic body diodes in the mosfets and charges VCC. An example of this behavior is illustrated by the two pictures in the top half of Figure 15. When the driver is active, the current flows from S1 to the motor and then to S6 and is returned to ground. When the driver is placed into a high impedance (tri-state) mode, the current goes flows from ground through the body diode of S2 to the motor and then through the body diode of S5 to VCC. The current will continue to flow through the motor's inductance in this direction until the inductive energy is dissipated.

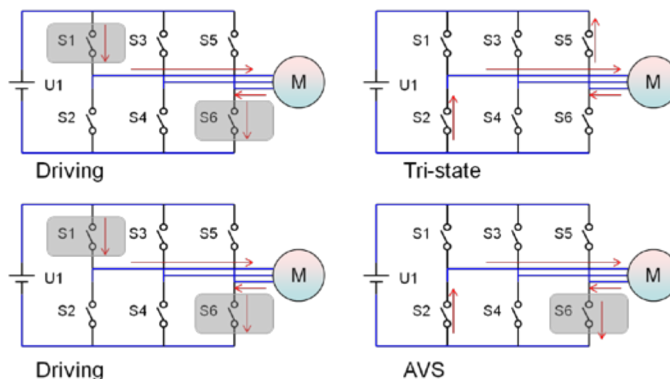


Figure 15. Inductive AVS

The lower two pictures in Figure 14 illustrate how the AVS circuit in the DRV10963 device prevents this energy from being returned to the supply. When the AVS condition is detected the DRV10963 device will act to turn on the low side device designated as S6. This allows the current flowing in the motor inductance to be returned to ground instead of being directed to the VCC supply voltage.

7.3.9 Control Advance Angle

To achieve the best efficiency it is often desirable to control the drive state of the motor so that the motor’s phase current is aligned with the motor’s BEMF voltage.

To align the motor’s phase current with the motor’s BEMF voltage the inductive effect of the motor must be considered. The voltage applied to the motor should be applied in advance of the motor’s BEMF voltage. This is illustrated in Figure 16. The DRV10963 provides configuration bits (CTRL_ANG[4:0])for controlling the time (Tadv) between the driving voltage and BEMF. For motors with salient pole structures, aligning the motor BEMF voltage with the motor current may not achieve the best efficiency. In these applications the timing advance should be adjusted accordingly. This can be accomplished by operating the system at constant speed and load conditions and by adjusting the Tadv until the minimum current is achieved.

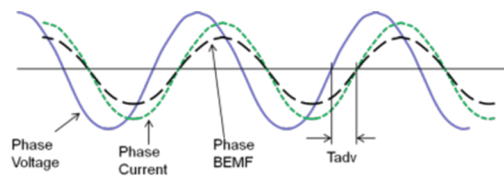


Figure 16. DRV10963 Advance Angle Control

Table 8. Control Advance Angle Settings

CTRL_ANG[4:0]	Tadv
0	0
1	20 μs
2	40 μs
3	60 μs
n	n × 20 μs
6	120 μs
8	160 μs
31	620 μs

7.3.10 Overtemperature Protection

The DRV10963 contains a thermal shut down function which disables motor operation when the device junction temperature has exceeded T_{SD}. Motor operation will resume when the junction temperature becomes lower than T_{SD} - T_{SD_HYS}.

7.3.11 Undervoltage Protection

The DRV10963 contains an undervoltage lockout feature, which prevents motor operation whenever the supply voltage (VCC) becomes too low. Upon power up, the DRV10963 will operate once VCC rises above V_{UVLO_H}. The DRV10963 will continue to operate until VCC falls below V_{UVLO_L}.

7.3.12 OTP Configuration

The DRV10963 features OTP (one time programmable) bits to allow for flexible configuration of the device in order for optimization over a wide range of applications. Selection of various OTP options is described throughout this specification. The DRV10963JJ, DRV10963JM, DRV10963JU, and DRV10963JA parts listed in Table 10 are configured at the factory based on popular OTP settings for several different applications. TI provides EVM hardware along with a special GUI and a Motor System Tuning Guide which provides detailed instructions for determining the right part for your application. If your application requires settings not provided in

any of the DRV10963Jx parts then the DRV10963P part can be used. The DRV10963P part provides blank OTP settings that can be configured for optimal performance in your application. The TI provided EVM and GUI will allow you to configure the OTP settings. Consult your TI representative if your application requires settings that are not available in the DRV10963Jx configurations described and if you are unable to use the DRV10963P option. The OTP bits used to configure the various part revisions are shown for reference in [Table 10](#).

Table 9. OTP Configuration Bits

OTP BIT NAMES	DESCRIPTION	REFERENCE TO
MINOP_DC[1:0]	Minimum operational duty cycle	Figure 6
SLEEP_EN	Sleep mode enable	Standby Mode and Sleep Mode
TARA_TH[3:0]	Start-up time and accelerate setting	Spin up Settings
HO_TH[3:0]	Openloop to closed loop threshold.	Spin up Settings
ILIMIT[2:0]	Current limit setting.	Table 7
CTRL_ANG[4:0]	Control advance angle.	Table 8
FGOPT	FG output option.	Motor Frequency Feedback (FG)

Table 10. The OTP Setting of the Factory Configured Parts

	MINOP_DC [1:0]	SLEEP_EN	TARA_TH [3:0]	HO_TH [3:0]	ILIMIT [2:0]	CTRL_ANG [4:0]	FGOPT
DRV10963JJ	2	1	7	8	4	6	0
DRV10963JM	2	1	E	4	4	6	1
DRV10963JU	2	1	C	7	4	6	0
DRV10963JA	2	1	7	8	4	8	0
DRV10963P	0	0	0	0	0	0	0

7.4 Device Functional Modes

7.4.1 Standby Mode and Sleep Mode

When the PWM commanded duty cycle input is lower than 1.5%, the phase outputs will be put into a high impedance state. The device will stop driving the motor. The device logic is still active during standby mode and the DRV10963 device will consume current as specified by I_{VCC} .

When the PWM commanded duty cycle input is driven to 0% (less than V_{IL_PWM} for at least T_{SLEEP} time), the DRV10963 device will enter a low power sleep mode. In sleep mode, most of the circuitry in the device will be disabled to minimize the system current. The current consumption in this state is specified by I_{VCC_SLEEP} .

The device will remain in sleep mode until either the PWM commanded duty cycle input is driven to a logic high (higher than V_{IH_PWM}) or the PWM input pin is allowed to float. If the input is allowed to float an internal pullup resistor will raise the voltage to a logic high level.

Recovering from sleep mode is treated the same as power on condition as illustrated in [Figure 7](#).

As part of the device initialization the motor resistance value and the motor Kt value are measured during the initial motor spin up as shown in [Figure 7](#). Whenever the part is executing the initialization sequence it is important to note that the values determined by any previous spin up cycles no longer exist. In order for the motor resistance value and the motor Kt value to be properly initialized the system should be allowed to come to a complete stop before the next restart attempt.

Device Functional Modes (continued)

Sleep mode can be disabled by OTP setting (SLEEP_EN). In this condition, the motor resistance value and the motor Kt value are preserved and the motor can reliably spin up without coming to a complete stop. This feature is referred to as the 're-synchronize' function. If the 're-synchronize' function is required the sleep mode cannot be used.

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

DRV10963 is used in sensorless 3-phase BLDC motor control. The driver provides a high performance, high reliability, flexible and simple solution for compute fan applications. The following design shows a common application of the DRV10963.

8.2 Typical Application

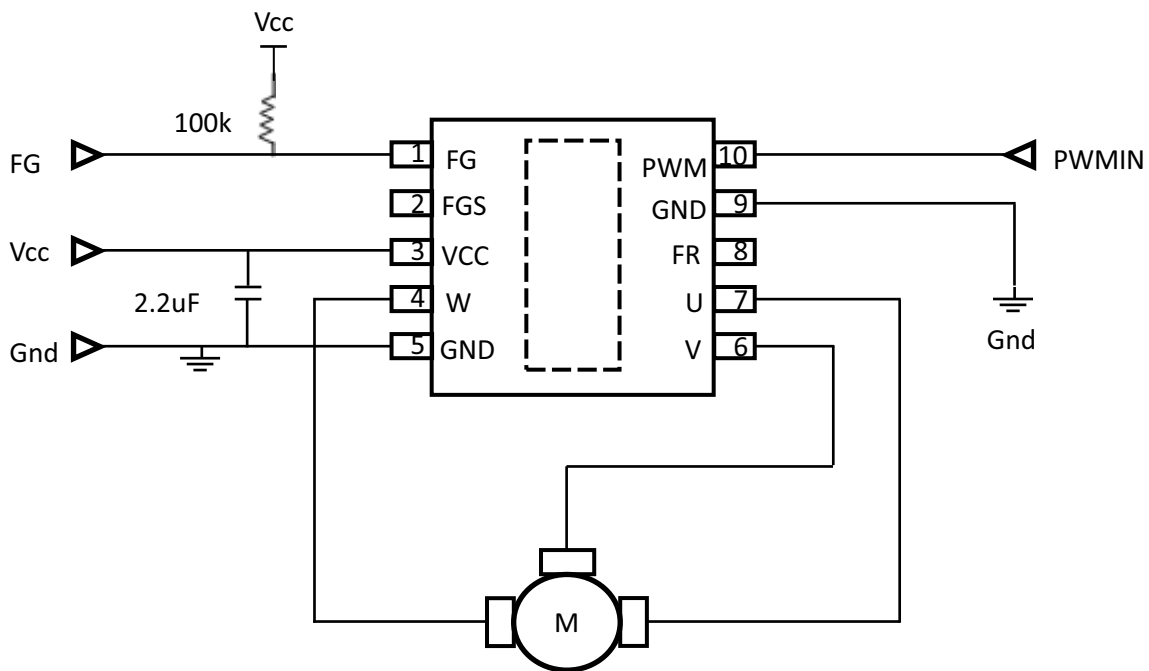


Figure 17. Typical Application Schematic

8.2.1 Design Requirements

Table 11 lists several key motor characteristics and recommended ranges which the DRV10963 is capable of driving. However, that does not necessarily mean motors outside these boundaries cannot be driven by DRV10963.

Recommended ranges listed in Table 11 can serve as a general guideline to quickly decide whether DRV10963 is a good fit for an application. Motor performance is not ensured for all uses.

Table 11. Key Motor Characteristics and Recommended Ranges

	Rm (Ω)	Lm (μH)	Kt (mV/Hz)	f _{FG_max} (Hz)
Recommended Value	2.5 ~ 36	50 ~ 10000	1 ~ 100	1300

Rm - Motor phase resistance between phase to phase;

Lm - Motor phase to phase inductance between phase to phase;

Kt - Motor BEMF constant from phase to center tape;

f_{FG_max} - Maximum electrical frequency. Maximum motor speed can be calculated from:

- If FGS = 1, RPM = (f_{FG_max} × 60)/ number of pole pairs
- If FGS = 0, RPM = (f_{FG_max} × 120)/ number of pole pairs

8.2.2 Detailed Design Procedure

1. Refer to [Design Requirements](#) and make sure your system meets the recommended application range.
2. Refer to the DRV10963 Tuning Guide and measure the motor parameters.
3. Refer to the DRV10963 Tuning Guide. Configure the parameters using DRV10963 GUI, and optimize the motor operation. The Tuning Guide takes the user through all the configurations step by step, including: start-up operation, closed-loop operation, current control, initial positioning, lock detection, and anti-voltage surge.
4. Build your hardware based on Layout Guidelines.
5. Connect the device into system and validate your system solution

8.2.3 Application Curves

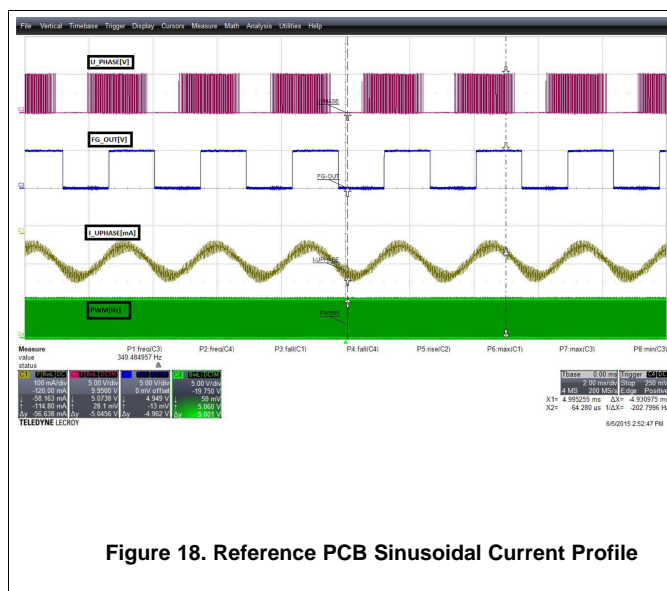


Figure 18. Reference PCB Sinusoidal Current Profile

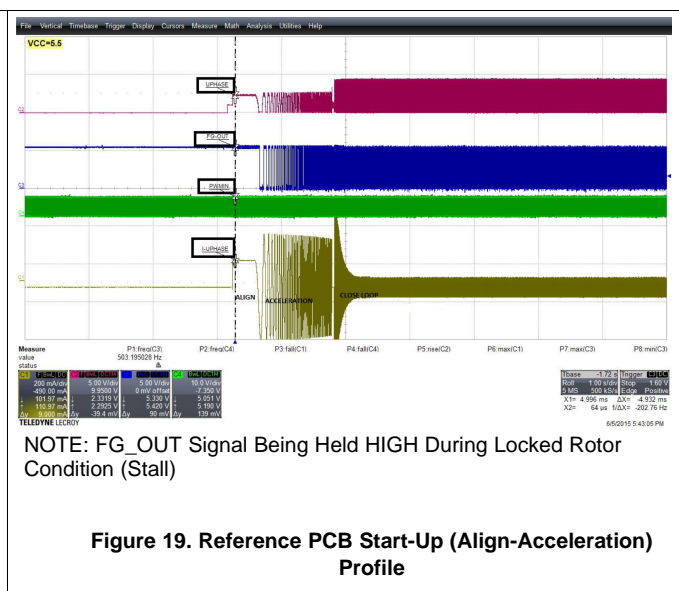


Figure 19. Reference PCB Start-Up (Align-Acceleration) Profile

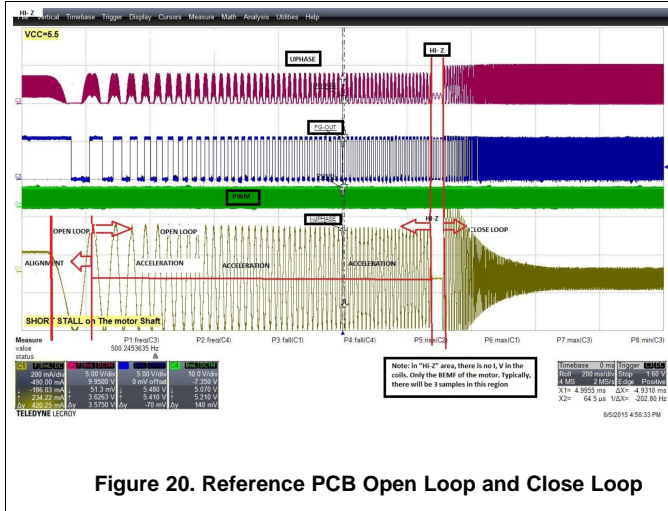


Figure 20. Reference PCB Open Loop and Close Loop

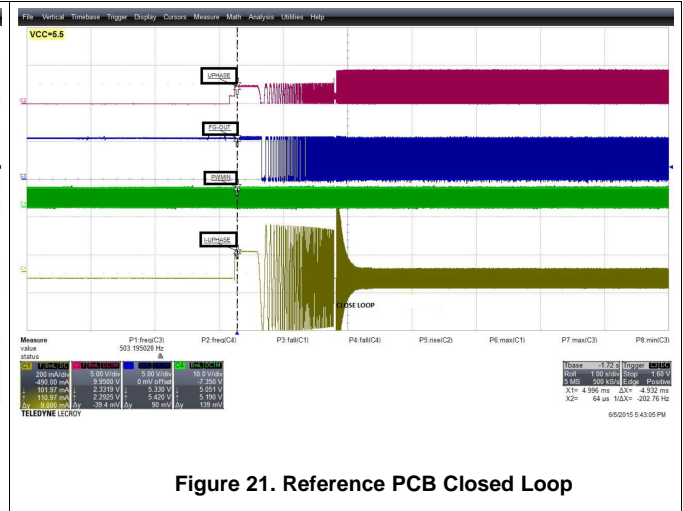


Figure 21. Reference PCB Closed Loop

9 Power Supply Recommendations

The DRV10963 is designed to operate from an input voltage supply, V(VCC), range from 2.1 and 5.5 V. The user must place a 2.2- μ F ceramic capacitor rated for VCC as close as possible to the VCC and GND pin.

10 Layout

10.1 Layout Guidelines

The package uses an exposed pad to remove heat from the device. For proper operation, this pad must be thermally connected to copper on the PCB to dissipate heat. On a multi-layer PCB with a ground plane, this can be accomplished by adding a number of vias to connect the thermal pad to the ground plane. On PCBs without internal planes, copper area can be added on either side of the PCB to dissipate heat. If the copper area is on the opposite side of the PCB from the device, thermal vias are used to transfer the heat between top and bottom layers.

For details about how to design the PCB, refer to TI application report, *PowerPAD™ Thermally Enhanced Package (SLMA002)*, and TI application brief, *PowerPAD™ Made Easy (SLMA004)*, available at www.ti.com. In general, the more copper area that can be provided, the more power can be dissipated.

10.2 Layout Example

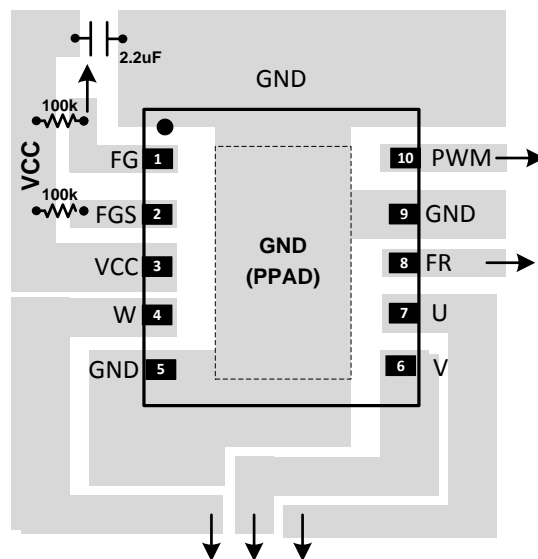


Figure 22. DRV10963 Layout Example

11 器件和文档支持

11.1 社区资源

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11.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 机械、封装和可订购信息

以下页中包括机械封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本档进行修订的情况下发生改变。欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
DRV10963DSNR	Obsolete	Production	SON (DSN) 10	-	-	Call TI	Call TI	-40 to 125	10963B
DRV10963JADSNR	Obsolete	Production	SON (DSN) 10	-	-	Call TI	Call TI	-40 to 125	963JA
DRV10963JJDSNR	Obsolete	Production	SON (DSN) 10	-	-	Call TI	Call TI	-40 to 125	963JJ
DRV10963JJDSNT	Obsolete	Production	SON (DSN) 10	-	-	Call TI	Call TI	-40 to 125	963JJ
DRV10963JMDSNR	Obsolete	Production	SON (DSN) 10	-	-	Call TI	Call TI	-40 to 125	963JM
DRV10963JUDSNR	Obsolete	Production	SON (DSN) 10	-	-	Call TI	Call TI	-40 to 125	963JU
DRV10963PDSNT	Obsolete	Production	SON (DSN) 10	-	-	Call TI	Call TI	-40 to 125	963P

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

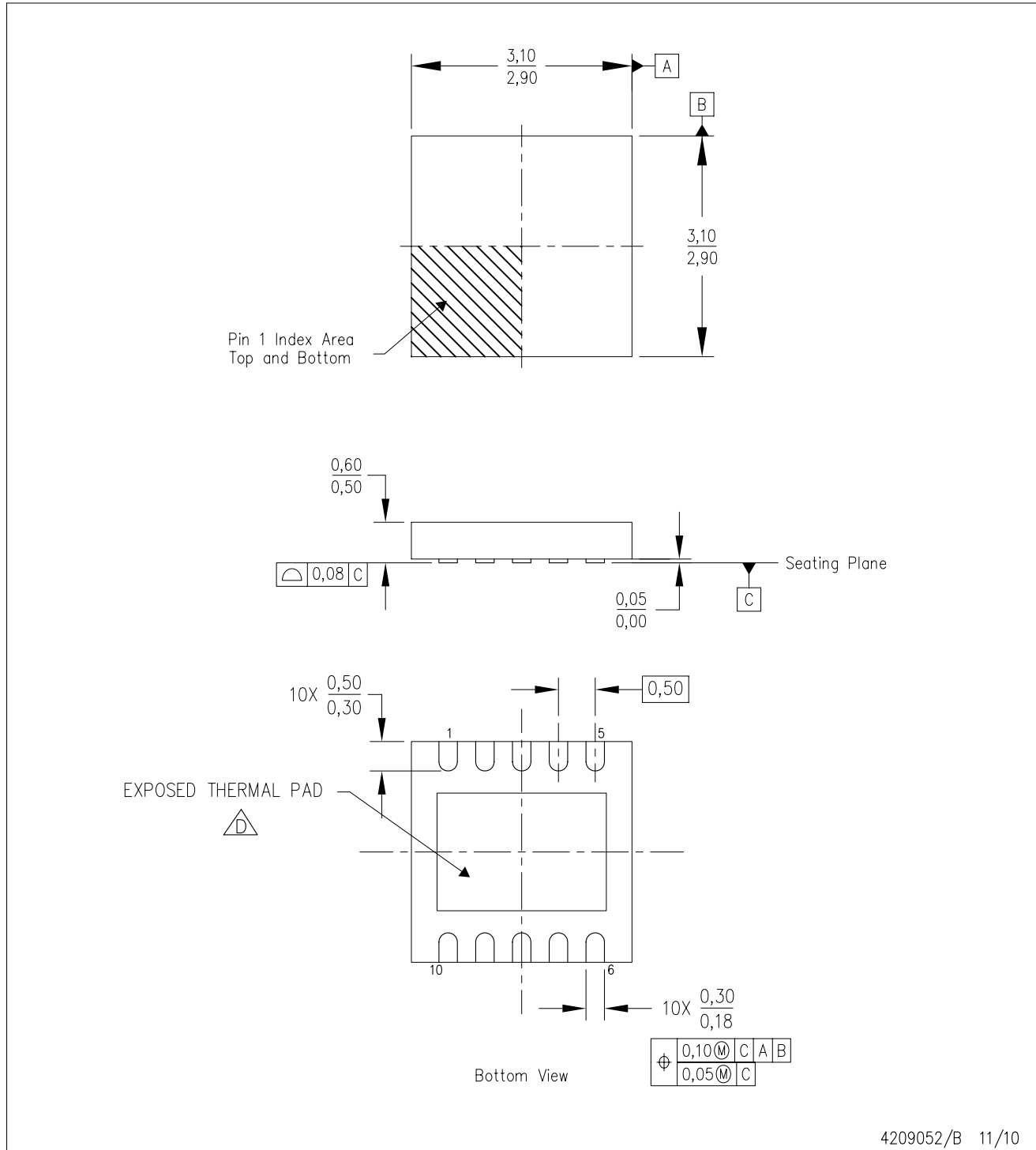
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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DSN (S-PUSON-N10)

PLASTIC QUAD FLATPACK NO-LEAD



4209052/B 11/10

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5-1994.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-Lead) package configuration.
 -  D. The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.

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